

ABSTRACT OF THE DISCLOSURE

5 A surface acoustic wave device includes a surface  
acoustic wave filter element having a piezoelectric  
substrate on which comb-like electrodes are formed, and  
a package having a first cavity in which the surface  
acoustic wave filter is housed. The package includes a  
flexible chip mounting base having a first surface on  
which the surface acoustic wave filter is mounted and  
having a thickness equal to or less than 100  $\mu\text{m}$ .

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